NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

Rev. 11 — 9 December 2011

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

NPN Resistor-Equipped Transistor (RET) family in Surface-Mounted Device (SMD) plastic packages.

#### Table 1. Product overview

Type number	Package	-			Package
	NXP	JEITA	JEDEC	complement	configuration
PDTC143XE	SOT416	SC-75	-	PDTA143XE	ultra small
PDTC143XM	SOT883	SC-101	-	PDTA143XM	leadless ultra small
PDTC143XT	SOT23	-	TO-236AB	PDTA143XT	small
PDTC143XU	SOT323	SC-70	-	PDTA143XU	very small

### 1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design

#### **1.3 Applications**

- Digital applications in automotive and industrial segments
- Control of IC inputs

- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified
- Cost-saving alternative for BC847/857 series in digital applications
- Switching loads

#### 1.4 Quick reference data

#### Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	50	V
I <sub>O</sub>	output current		-	-	100	mA
R1	bias resistor 1 (input)		3.3	4.7	6.1	kΩ
R2/R1	bias resistor ratio		1.7	2.1	2.6	



NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

### 2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
SOT23; S	SOT323; SOT416		
1	input (base)	_	
2	GND (emitter)	3	
3	output (collector)	2	1 R1 R2 sym007
SOT883			
1	input (base)		
2	GND (emitter)		
3	output (collector)	2 Transparent top view	1 R1 R2 Sym007

### 3. Ordering information

Type number	Package	ickage					
	Name	Description	Version				
PDTC143XE	SC-75	plastic surface-mounted package; 3 leads	SOT416				
PDTC143XM	SC-101	leadless ultra small plastic package; 3 solder lands; body 1.0 $\times$ 0.6 $\times$ 0.5 mm	SOT883				
PDTC143XT	-	plastic surface-mounted package; 3 leads	SOT23				
PDTC143XU	SC-70	plastic surface-mounted package; 3 leads	SOT323				

### 4. Marking

Table 5.   Marking codes	
Type number	Marking code <sup>[1]</sup>
PDTC143XE	34
PDTC143XM	E2
PDTC143XT	*32
PDTC143XU	*53

[1] \* = placeholder for manufacturing site code

## PDTC143X\_SER Product data sheet

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NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

### 5. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	7	V
VI	input voltage				
	positive		-	+20	V
	negative		-	-7	V
lo	output current		-	100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 ms$	-	100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	PDTC143XE (SOT416)		[1][2] _	150	mW
	PDTC143XM (SOT883)		[2][3]	250	mW
	PDTC143XT (SOT23)		<u>[1]</u> -	250	mW
	PDTC143XU (SOT323)		<u>[1]</u> -	200	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

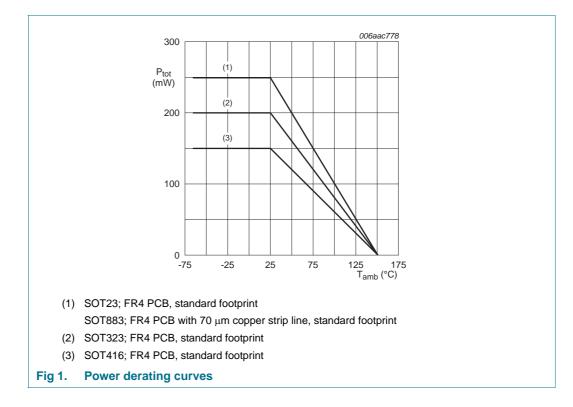
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70 µm copper strip line, standard footprint.

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NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 



### 6. Thermal characteristics

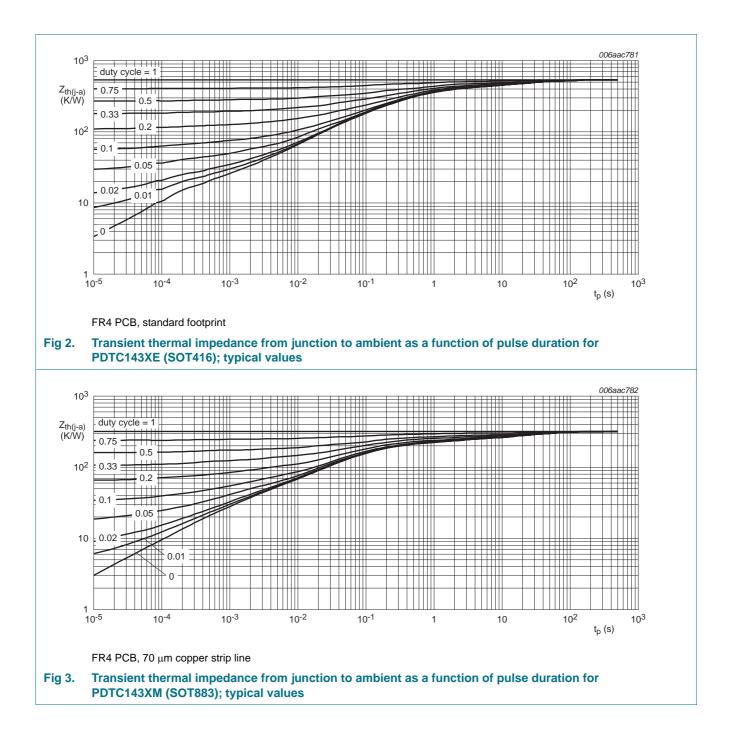
Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air				
	PDTC143XE (SOT416)		[1][2]	-	830	K/W
	PDTC143XM (SOT883)		[2][3]	-	500	K/W
	PDTC143XT (SOT23)		<u>[1]</u> _	-	500	K/W
	PDTC143XU (SOT323)		<u>[1]</u> _	-	625	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

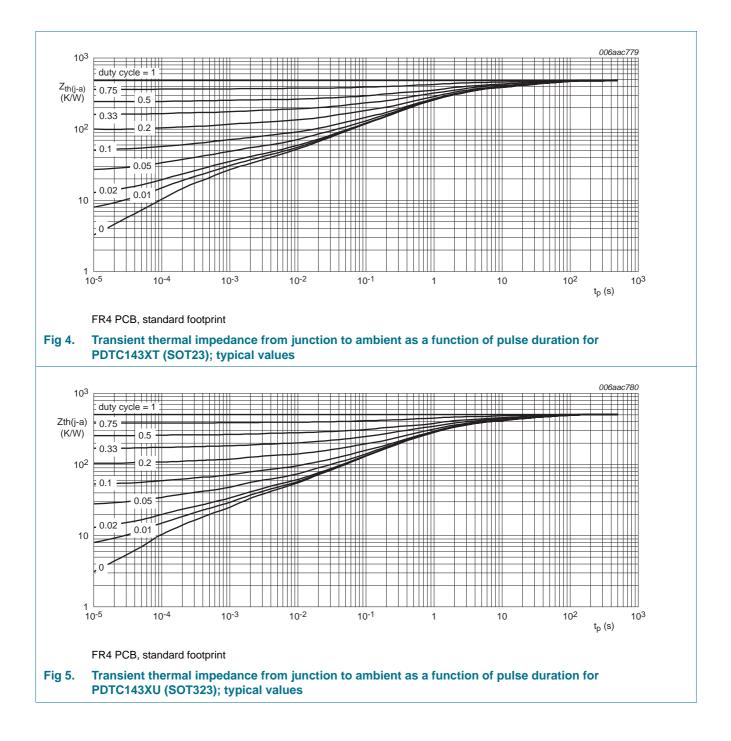
[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70  $\mu$ m copper strip line, standard footprint.

# **PDTC143X series**



# **PDTC143X series**



NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

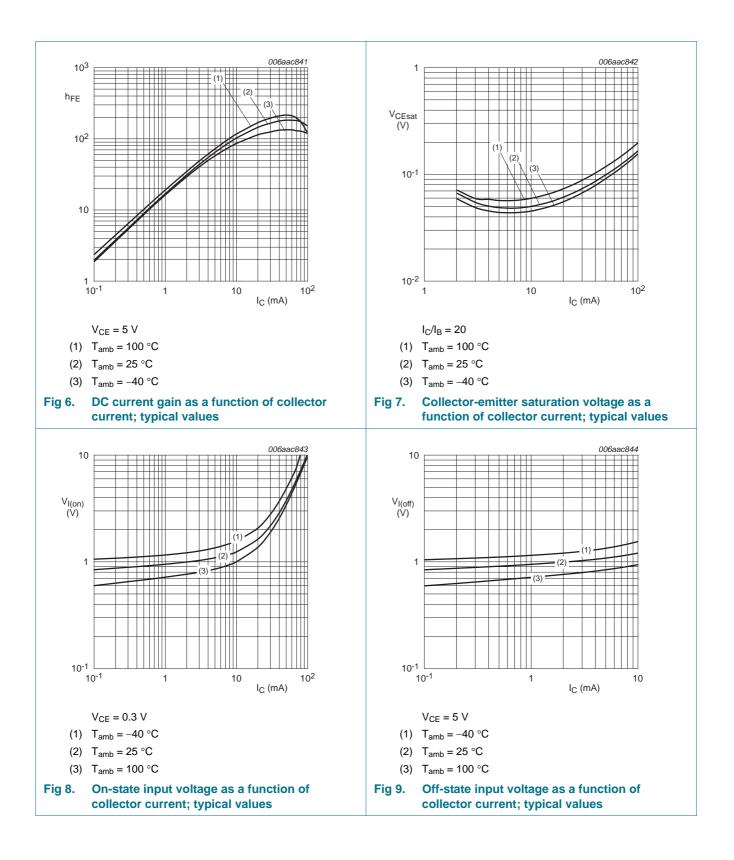
### 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$		-	-	100	nA
I <sub>CEO</sub>	collector-emitter	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$		-	-	1	μA
	cut-off current	V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0 A; T <sub>j</sub> = 150 °C		-	-	5	μA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$		-	-	600	μA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA}$		50	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{C}$ = 10 mA; $I_{B}$ = 0.5 mA		-	-	100	mV
V <sub>I(off)</sub>	off-state input voltage	$V_{CE}$ = 5 V; $I_C$ = 100 $\mu$ A		-	0.9	0.3	V
V <sub>I(on)</sub>	on-state input voltage	$V_{CE}$ = 0.3 V; $I_{C}$ = 20 mA		2.5	1.5	-	V
R1	bias resistor 1 (input)			3.3	4.7	6.1	kΩ
R2/R1	bias resistor ratio			1.7	2.1	2.6	
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz		-	-	2.5	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 10 mA; f = 100 MHz	<u>[1]</u>	-	230	-	MHz

[1] Characteristics of built-in transistor

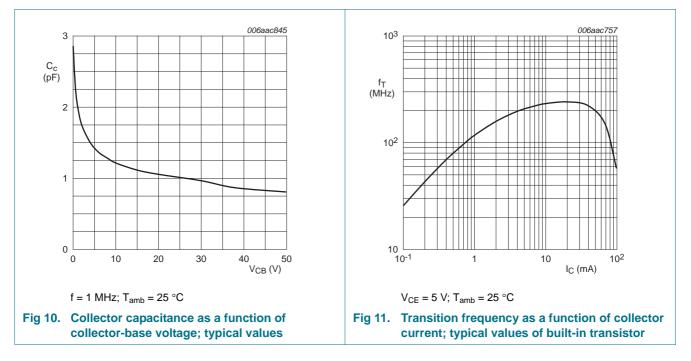
PDTC143X\_SER
Product data sheet

# **PDTC143X series**



# **PDTC143X series**

NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 



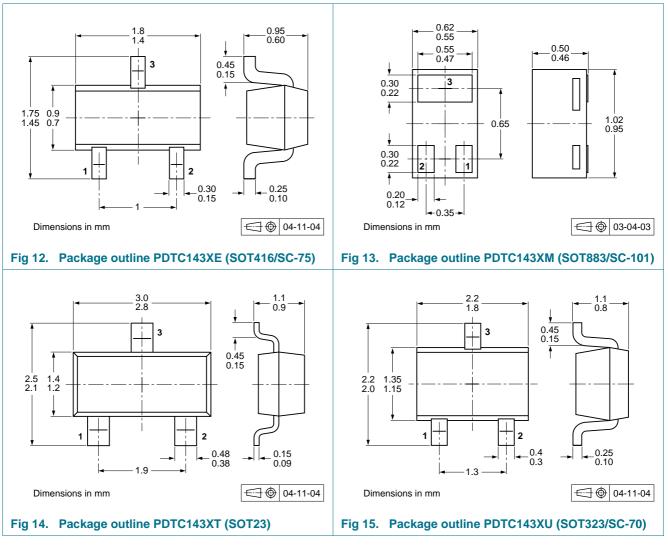
### 8. Test information

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

#### **Package outline** 9.



### **10. Packing information**

#### Table 9. **Packing methods**

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

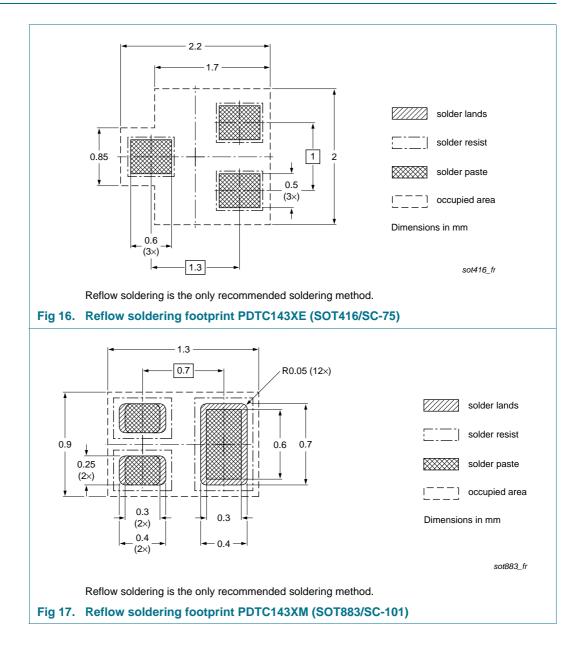
Type number	Package	Description	Packing	Packing quantity		
			3000	5000	10000	
PDTC143XE	SOT416	4 mm pitch, 8 mm tape and reel	-115	-	-135	
PDTC143XM	SOT883	2 mm pitch, 8 mm tape and reel	-	-	-315	
PDTC143XT	SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-235	
PDTC143XU	SOT323	4 mm pitch, 8 mm tape and reel	-115	-	-135	

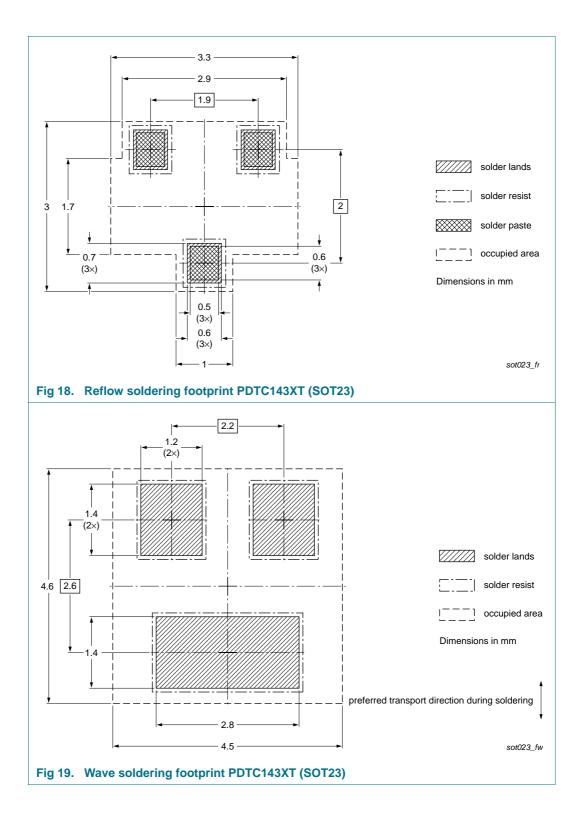
[1] For further information and the availability of packing methods, see Section 14.

PDTC143X\_SER Product data sheet

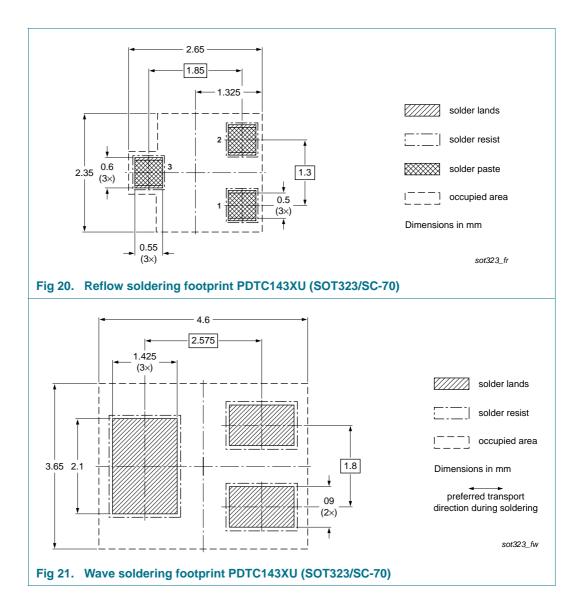
NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

### 11. Soldering





NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 



PDTC143X\_SER
Product data sheet

NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

### 12. Revision history

#### Table 10.Revision history

PDTC143X_SER v.11       20111209       Product data sheet       -       PDTC143X_SER         Modifications:       • Type numbers PDTC143XEF, PDTC143XK and PDTC143XS removed.       • Section 1 "Product profile": updated       • Section 2 "Pinning information": updated       • Section 2 "Pinning information": updated       • Section 4 "Marking": updated       • Section 4 "Marking": updated       • Section 4 "Marking": updated       • Section 6 "Thermal characteristics": updated       • Figure 1 to 5, 10 and 11: added       • Section 6 "Thermal characteristics": updated       • Figure 6 to 9: updated       • Figure 6 to 9: updated       • Section 8 "Test information": added       • Section 11 "Soldering": added       • Section 11 "Soldering": added       • Section 11 "Soldering": updated       • Section 13 "Legal information": updated       • PDTC143X_SER         PDTC143X_SERIES v.10       20091116       Product data sheet       -       PDTC143X_SER	RIES v.10
<ul> <li>Section 1 "Product profile": updated</li> <li>Section 2 "Pinning information": updated</li> <li>Section 4 "Marking": updated</li> <li>Figure 1 to 5, 10 and 11: added</li> <li>Section 6 "Thermal characteristics": updated</li> <li>Section 6 "Thermal characteristics": updated</li> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 8 "Test information": added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
<ul> <li>Section 2 "Pinning information": updated</li> <li>Section 4 "Marking": updated</li> <li>Figure 1 to 5, 10 and 11: added</li> <li>Section 6 "Thermal characteristics": updated</li> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
<ul> <li>Section 4 "Marking": updated</li> <li>Figure 1 to 5, 10 and 11: added</li> <li>Section 6 "Thermal characteristics": updated</li> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 8 "Test information": added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
Figure 1 to 5, 10 and 11: added         Section 6 "Thermal characteristics": updated         Figure 6 to 9: updated         Table 8 "Characteristics": V <sub>I(on)</sub> and V <sub>I(off)</sub> updated, I <sub>CEO</sub> updated, f <sub>T</sub> added         Section 8 "Test information": added         Section 11 "Soldering": added         Section 13 "Legal information": updated         PDTC143X_SERIES v.10       20091116	
<ul> <li>Section 6 "Thermal characteristics": updated</li> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 8 "Test information": added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10</li> </ul>	
<ul> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 8 "Test information": added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
<ul> <li><u>Table 8 "Characteristics</u>": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li><u>Section 8 "Test information</u>": added</li> <li><u>Section 11 "Soldering</u>": added</li> <li><u>Section 13 "Legal information</u>": updated</li> <li><u>PDTC143X_SERIES v.10</u> 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
Section 8 "Test information": added     Section 11 "Soldering": added     Section 13 "Legal information": updated  PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 20091116 PDTC143X_SERIES v.10 20091116 PDTC143X_SERIES v.10 PDTC143X_SERIES v.10 20091116 PDTC143X_SERIES v.10 PDTC143Y_SERIES v.10 PDTC143Y_SER	
Section 11 "Soldering": added     Section 13 "Legal information": updated  PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 PDTC143Y_SERIES v.10 PDTC143Y_SERIES v.10 PDTC143Y_SERIES	
Section 13 "Legal information": updated  PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 20091116 PDTC143X_SERIES v.10 PDTC143X_SERIE	
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PDTC143X_SERIES v.5 20031112 Product specification - PDTC143X_SE	
PDTC143X_SERIES v.4 20030910 Product specification - PDTC143X_SE	
PDTC143X_SERIES v.3 20030410 Product specification	RIES v.4

### **13. Legal information**

#### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Product data sheet

#### NPN resistor-equipped transistors; $R1 = 4.7 \text{ k}\Omega$ , $R2 = 10 \text{ k}\Omega$

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### 14. Contact information

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# **PDTC143X series**

NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

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